

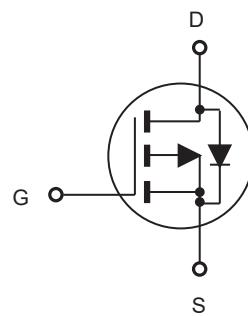
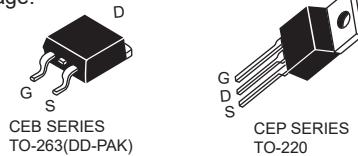


# CEP110P06/CEB110P06

## P-Channel Enhancement Mode Field Effect Transistor

### FEATURES

- -60V, -113A,  $R_{DS(ON)} = 7.2m\Omega$  @ $V_{GS} = -10V$ .  
 $R_{DS(ON)} = 9m\Omega$  @ $V_{GS} = -4.5V$ .
- Super high dense cell design for extremely low  $R_{DS(ON)}$ .
- High power and current handing capability.
- Pb-free lead plating ; RoHS compliant.
- Halogen Free.
- TO-220 & TO-263 package.



### ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ C$ unless otherwise noted

Parameter	Symbol	Limit	Units
Drain-Source Voltage	$V_{DS}$	-60	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous @ $T_C = 25^\circ C$ @ $T_C = 100^\circ C$	$I_D$	-113 -72	A
Drain Current-Pulsed <sup>a</sup>	$I_{DM}$	-452	A
Maximum Power Dissipation @ $T_C = 25^\circ C$ - Derate above 25 $^\circ C$	$P_D$	166 1.3	W W/ $^\circ C$
Single Pulsed Avalanche Energy <sup>d</sup>	$E_{AS}$	420	mJ
Single Pulsed Avalanche Current <sup>d</sup>	$I_{AS}$	29	A
Operating and Store Temperature Range	$T_J, T_{stg}$	-55 to 150	$^\circ C$

### Thermal Characteristics

Parameter	Symbol	Limit	Units
Thermal Resistance, Junction-to-Case	$R_{JC}$	0.75	$^\circ C/W$
Thermal Resistance, Junction-to-Ambient	$R_{JA}$	62.5	$^\circ C/W$



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## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	-60			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = -60\text{V}, V_{\text{GS}} = 0\text{V}$			-1	$\mu\text{A}$
Gate Body Leakage Current, Forward	$I_{\text{GSSF}}$	$V_{\text{GS}} = 20\text{V}, V_{\text{DS}} = 0\text{V}$			100	nA
Gate Body Leakage Current, Reverse	$I_{\text{GSSR}}$	$V_{\text{GS}} = -20\text{V}, V_{\text{DS}} = 0\text{V}$			-100	nA
<b>On Characteristics<sup>b</sup></b>						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}} = V_{\text{DS}}, I_D = -250\mu\text{A}$	-1		-3	V
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -10\text{V}, I_D = -20\text{A}$		5.5	7.2	$\text{m}\Omega$
		$V_{\text{GS}} = -4.5\text{V}, I_D = -15\text{A}$		7	9	$\text{m}\Omega$
<b>Dynamic Characteristics<sup>c</sup></b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = -30\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$		12195		pF
Output Capacitance	$C_{\text{oss}}$			690		pF
Reverse Transfer Capacitance	$C_{\text{rss}}$			235		pF
<b>Switching Characteristics<sup>c</sup></b>						
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = -30\text{V}, I_D = -20\text{A}, V_{\text{GS}} = -10\text{V}, R_{\text{GEN}} = 2.5\Omega$		22		ns
Turn-On Rise Time	$t_r$			11		ns
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$			217		ns
Turn-Off Fall Time	$t_f$			99		ns
Total Gate Charge	$Q_g$	$V_{\text{DS}} = -30\text{V}, I_D = -20\text{A}, V_{\text{GS}} = -4.5\text{V}$		89		nC
Gate-Source Charge	$Q_{\text{gs}}$			22		nC
Gate-Drain Charge	$Q_{\text{gd}}$			34		nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Drain-Source Diode Forward Current	$I_S$				-113	A
Drain-Source Diode Forward Voltage <sup>b</sup>	$V_{\text{SD}}$	$V_{\text{GS}} = 0\text{V}, I_S = -1\text{A}$			-1.2	V

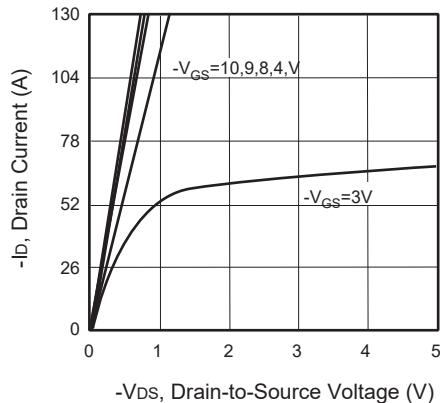
Notes :

a.Repetitive Rating : Pulse width limited by maximum junction temperature.

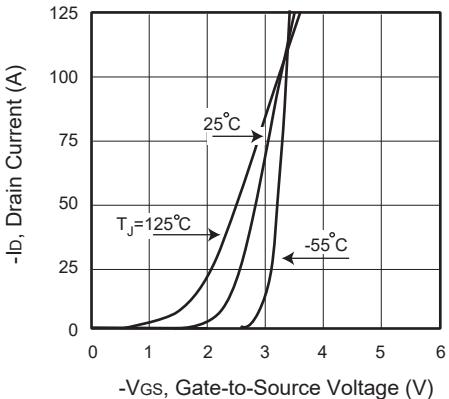
b.Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

c.Guaranteed by design, not subject to production testing.

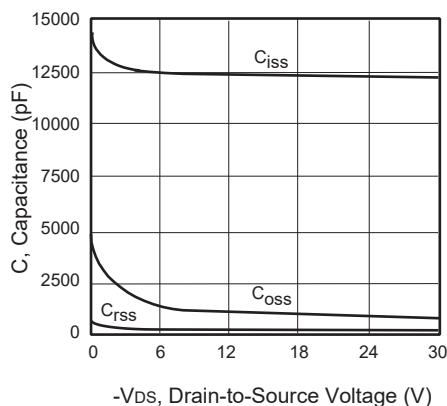
d.L = 1mH,  $I_{AS} = 29\text{A}$ ,  $V_{DD} = 24\text{V}$ ,  $R_G = 25\Omega$ , Starting  $T_J = 25^\circ\text{C}$ .



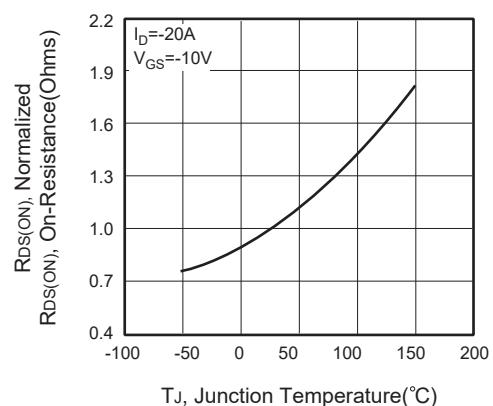
**Figure 1. Output Characteristics**



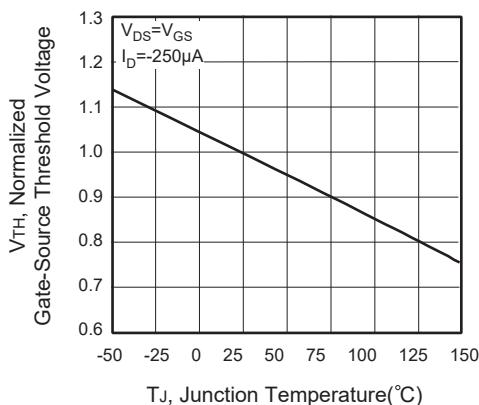
**Figure 2. Transfer Characteristics**



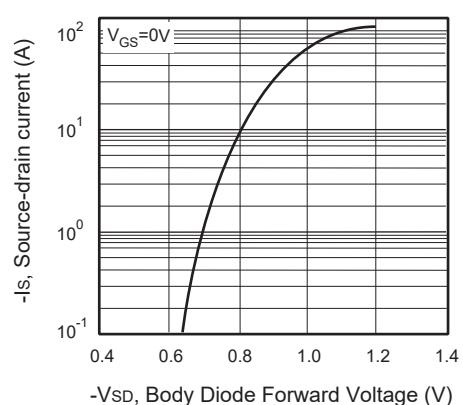
**Figure 3. Capacitance**



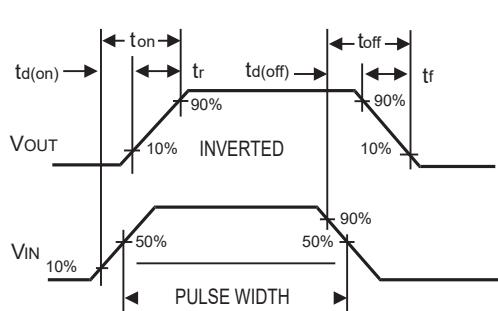
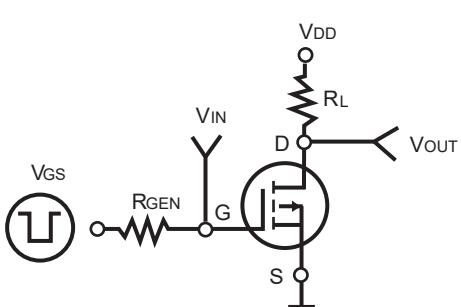
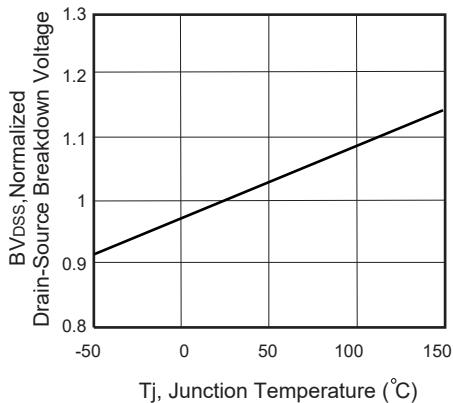
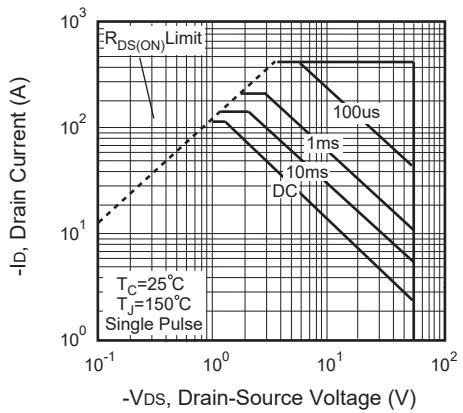
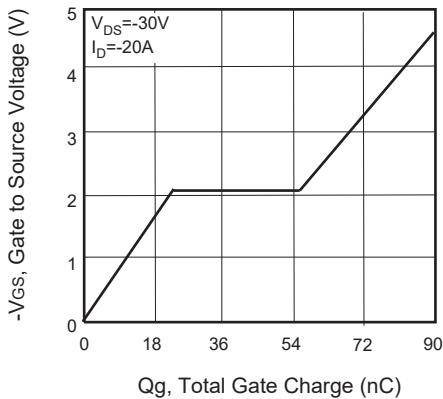
**Figure 4. On-Resistance Variation with Temperature**



**Figure 5. Gate Threshold Variation with Temperature**



**Figure 6. Body Diode Forward Voltage Variation with Source Current**





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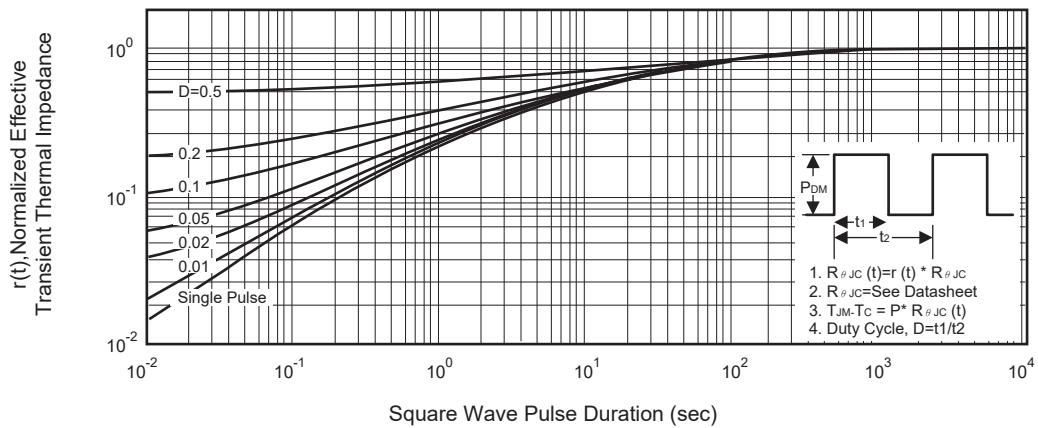


Figure 12. Normalized Thermal Transient Impedance Curve